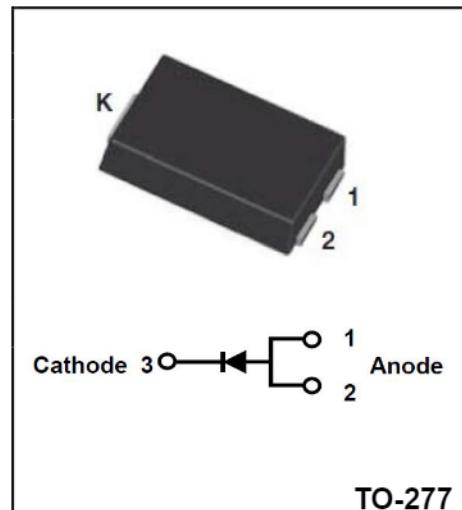


**Trench MOS Barrier Schottky Rectifier**
**Reverse Voltage - 150 V**
**Forward Current - 10 A**
**FEATURES**

- ◆ Advanced trench technology
- ◆ Low forward voltage drop
- ◆ Low power losses
- ◆ High efficiency operation
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives


**MECHANICAL DATA**

- ◆ Case: TO-277
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026


**Maximum Ratings (Per Leg) at Ta=25°C unless otherwise specified**

Parameter	Symbols	Value	Units
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	150	V
Maximum RMS voltage	V <sub>RMS</sub>	150	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	150	V
Maximum Average Forward Rectified Current Per diode	I <sub>F(AV)</sub>	10	A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave superimposed on rated load per diode	I <sub>FSM</sub>	280	A
Operating Temperature Range	T <sub>J</sub>	-55 ~ +150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 ~ +150	°C
Typical Thermal Resistance Per diode(munted on FR-4 PCB)	R <sub>θJC</sub>	20	°C/W

Note1: Thermal resistance from Junction to case per leg mounted on heatsink.

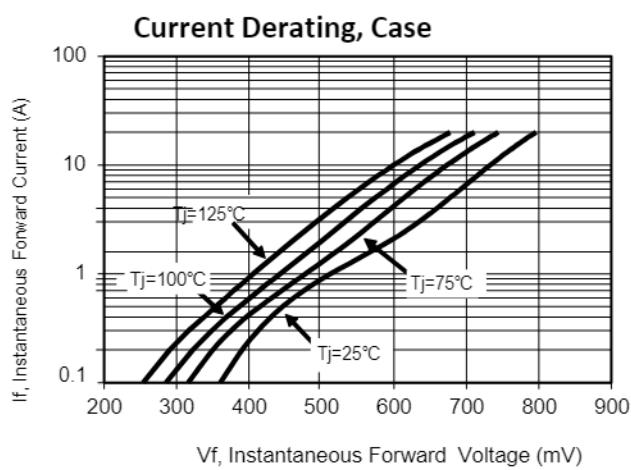
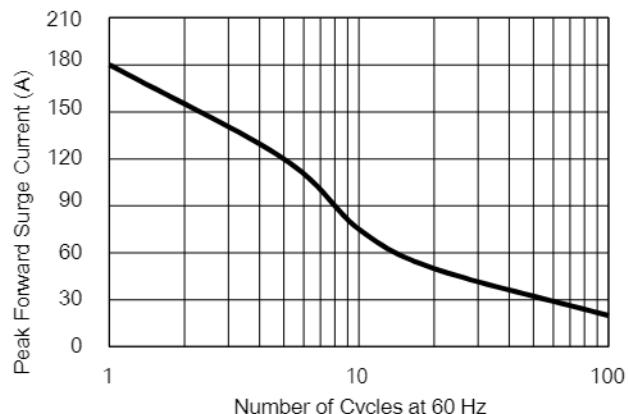
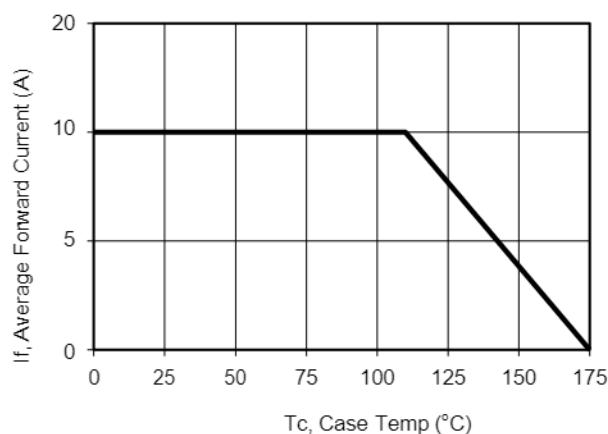
**Electrical Characteristics (Per Leg) unless otherwise specified**

Characteristics	Symbols	Value		Units
Forward Voltage Drop(Note2)	V <sub>F</sub>	Typ	Max	V
at I <sub>F</sub> =2A Instantaneous forward voltage per diode		0.56	-	
		0.50	-	
		0.71	0.78	
		0.65	-	
Instantaneous reverse current per diode at rated reverse voltage	I <sub>R</sub>	-	50	uA
		-	10	mA

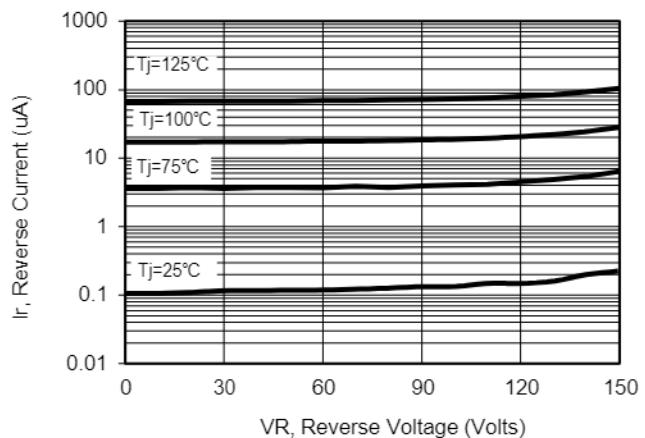
Note2: (1)Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

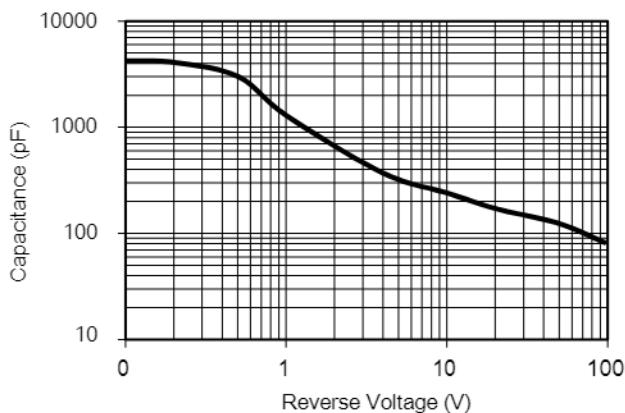
## RATINGS AND CHARACTERISTIC CURVES



### Maximum Repetitive Surge Current



### Typical Forward Voltage



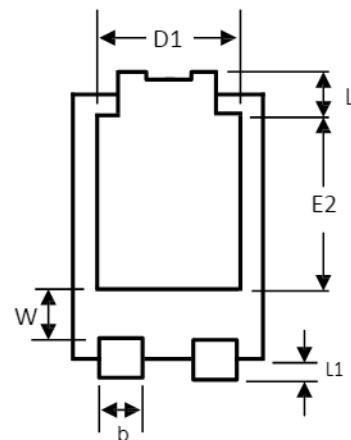
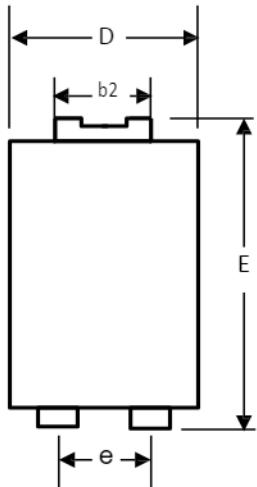
### Typical Junction Capacitance

### Typical Reverse Current

### Package Outline

TO-277

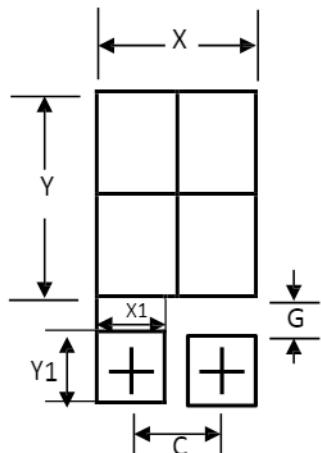
Plastic surface mounted package; 3leads



Dim	Min	Max
A	1.1	1.2
A2	0.3	0.4
b1	0.8	1
b2	1.7	1.9
D	3.9	4.1
D1	3.054	
E	6.4	6.6
e	1.84	
E1	5.3	5.5
E2	3.549	
L	0.8	1
L1	0.5	0.7
W	1.1	1.4

unit:mm

### Mounting Pad Layout



Dim	Min
C	1.8
G	0.9
X	3.4
X1	1.4
Y	4.9
Y1	1.4

unit:mm

### Summary of Packing Options

Package	Packing Description	Packing Quantity	Industry Standard
TO-277	Tape/Reel,13"reel	5000	EIA-481-1